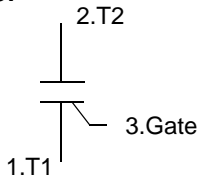


Triacs / Sensitive Gate

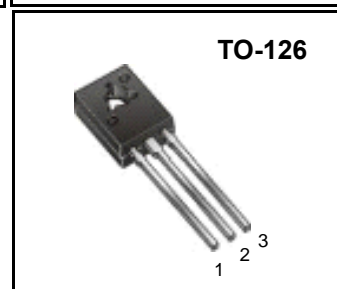
Features

Repetitive Peak Off-State Voltage : 800V
 R.M.S On-State Current ($I_{T(RMS)} = 4 \text{ A}$)
 High Commutation dv/dt
 Sensitive Gate Triggering 4 Mode

Symbol	
	$BV_{DRM} = 800V$ $I_{T(RMS)} = 4 \text{ A}$ $I_{TSM} = 25 \text{ A}$

General Description

This device is sensitive gate triac suitable for direct coupling to TTL, HTL, CMOS and application such as various logic functions, low power AC switching applications, such as fan speed, small light controllers and home appliance equipment.



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage	Sine wave, 50 to 60 Hz, Gate open	800	V
$I_{T(RMS)}$	R.M.S On-State Current	$T_C = 104^\circ\text{C}$, Full Sine wave	4	A
I_{TSM}	Surge On-State Current	One Cycle, 50Hz/60Hz, Peak, Non-Repetitive	25/27	A
I^2t	I^2t for Fusing	$t_p = 10\text{ms}$	3.1	A^2s
P_{GM}	Peak Gate Power Dissipation	$T_C = 104^\circ\text{C}$, Pulse width 1.0 μs	5	W
$P_{G(AV)}$	Average Gate Power Dissipation	Over any 20ms period	0.5	W
I_{GM}	Peak Gate Current	$t_p = 20\mu\text{s}$, $T_J = 125^\circ\text{C}$	2	A
V_{GM}	Peak Gate Voltage	$t_p = 20\mu\text{s}$, $T_J = 125^\circ\text{C}$	5	V
T_J	Operating Junction Temperature		- 40 ~ 125	$^\circ\text{C}$
T_{STG}	Storage Temperature		- 40 ~ 150	$^\circ\text{C}$

DBT134 - 800

Electrical Characteristics

Symbol	Items	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{DRM}	Repetitive Peak Off-State Current	$V_D = V_{DRM}$, Single Phase, Half Wave $T_J = 125\text{ }^\circ\text{C}$			0.5	mA
V_{TM}	Peak On-State Voltage	$I_T = 5\text{ A}$, Inst. Measurement		1.4	1.7	V
I_{GT1}^+	Gate Trigger Current	$V_D = 6\text{ V}$, $R_L = 10$			5	mA
I_{GT1}^-					5	
I_{GT3}^-					5	
I_{GT3}^+					10	
V_{GT1}^+	Gate Trigger Voltage	$V_D = 6\text{ V}$, $R_L = 10$			1.5	V
V_{GT1}					1.5	
V_{GT3}					1.5	
V_{GT3}^+					2.5	
V_{GD}	Non-Trigger Gate Voltage	$T_J = 125\text{ }^\circ\text{C}$, $V_D = 1/2 V_{DRM}$	0.2			V
$(dv/dt)_c$	Critical Rate of Rise Off-State Voltage at Commutation	$T_J = 125\text{ }^\circ\text{C}$, $[di/dt]_c = -0.75\text{ A/ms}$, $V_D = 2/3 V_{DRM}$	5.0			V/ μs
I_H	Holding Current			1.2		mA
$R_{th(j-c)}$	Thermal Impedance	Junction to case			3.5	$^\circ\text{C/W}$
$R_{th(j-a)}$	Thermal Impedance	Junction to ambient (In free air)			100	$^\circ\text{C/W}$

Notes :

1. Pulse Width 300us , Duty cycle 2%

DBT134 - 800

Fig 1. Gate Characteristics

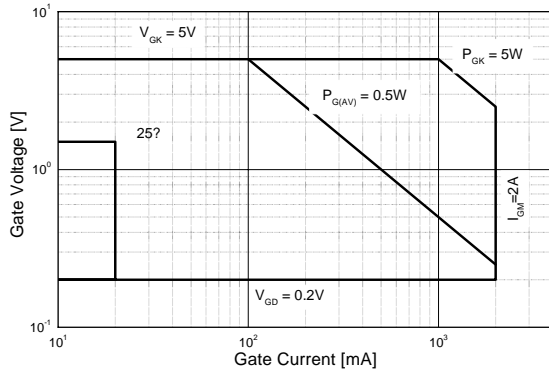


Fig 2. On-State Voltage

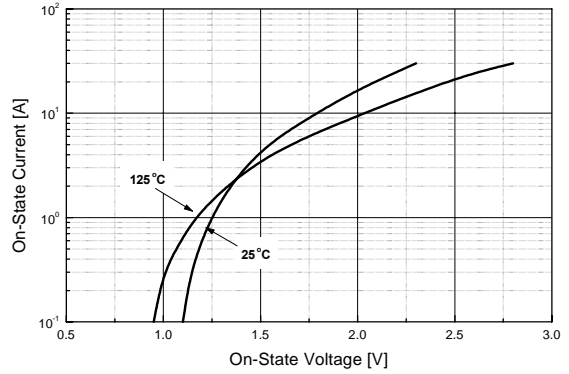


Fig 3. On State Current vs. Maximum Power Dissipation

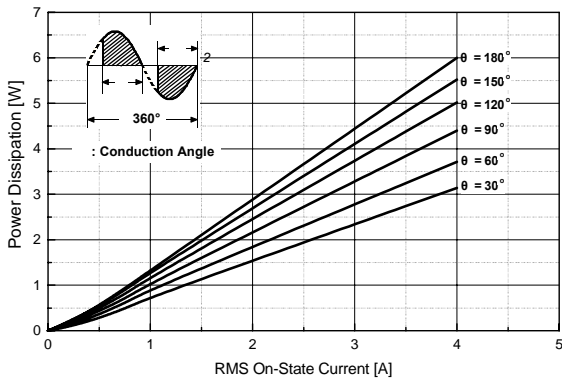


Fig 4. On State Current vs. Allowable Case Temperature

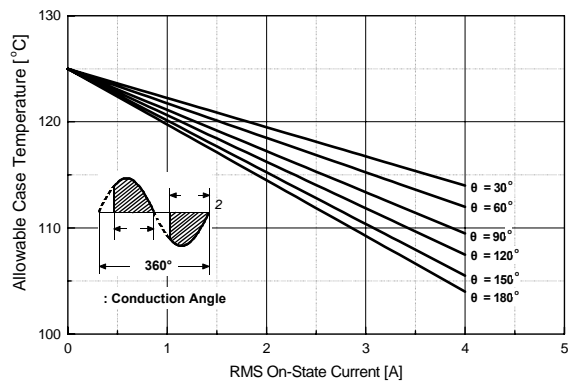


Fig 5. Surge On-State Current Rating (Non-Repetitive)

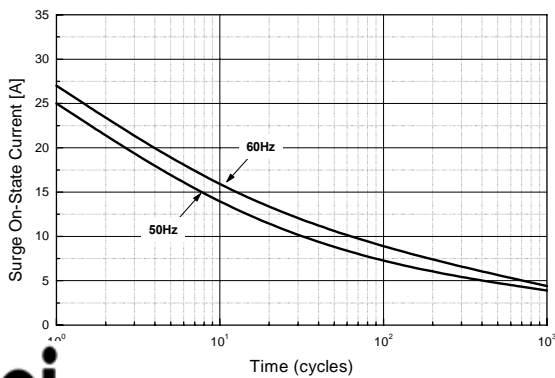
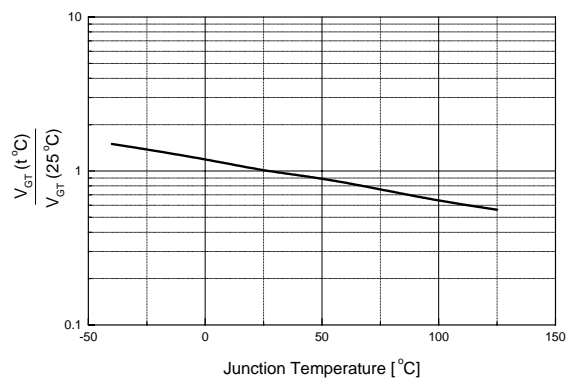


Fig 6. Gate Trigger Voltage vs. Junction Temperature



DBT134 - 800

Fig 7. Gate Trigger Current vs. Junction Temperature

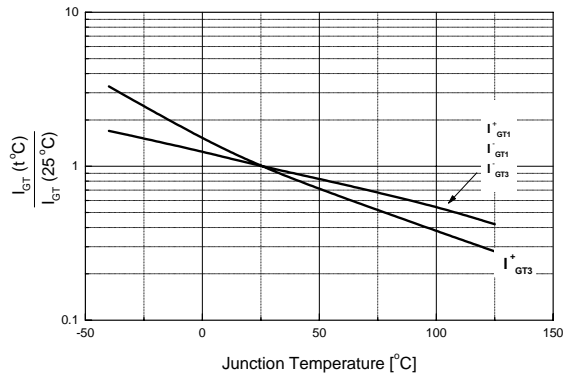


Fig 8. Transient Thermal Impedance

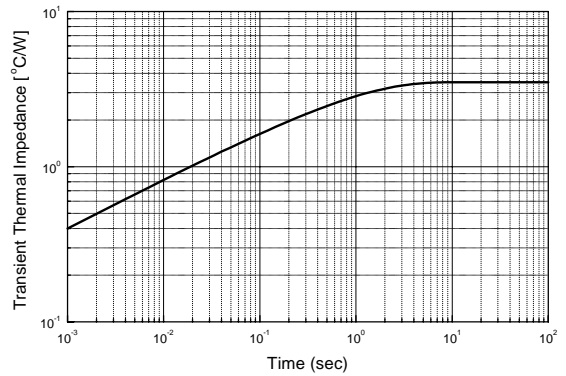
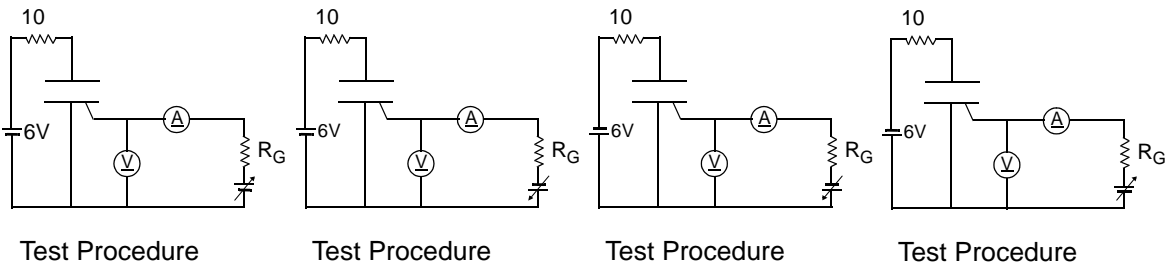


Fig 9. Gate Trigger Characteristics Test Circuit



DBT134 - 800

TO-126 Package Dimension

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.5		7.9	0.295		0.311
B	10.8		11.2	0.425		0.441
C	14.2		14.7	0.559		0.579
D	2.7		2.9	0.106		0.114
E		3.8			0.150	
F		2.5			0.098	
G	1.2		1.5	0.047		0.059
H		2.3			0.091	
I		4.6			0.181	
J	0.48		0.62	0.019		0.024
K	0.7		0.86	0.028		0.034
L		1.4			0.055	
		3.2			0.126	

